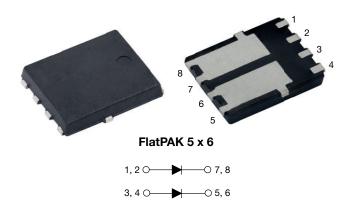
# VS-6DKH02HM3

### **Vishay Semiconductors**

## Hyper Fast Rectifier, 2 x 3 A FRED Pt®



PRODUCT SUMMARY						
Package	FlatPAK 5 x 6					
I <sub>F(AV)</sub>	2 x 3 A					
V <sub>R</sub>	200 V					
V <sub>F</sub> at I <sub>F</sub>	0.71 V					
t <sub>rr (typ.)</sub>	25 ns					
T <sub>J</sub> max.	175 °C					
Diode variation	Separated cathode					

#### **FEATURES**

- Hyper fast recovery time, reduced Q<sub>rr</sub>, and soft recovery
- 175 °C maximum operating junction temperature
- Specific for output and snubber operation
- Low forward voltage drop
- Low leakage current
- AEC-Q101 qualified
- Meets MSL level 1 per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **DESCRIPTION / APPLICATIONS**

State of the art hyper fast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyper fast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in snubber, boost, piezo-injection, as high frequency rectifiers, and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

### **MECHANICAL DATA**

Case: FlatPAK 5 x 6

Molding compound meets UL 94 V-0 flammability rating Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

HM3 suffix meets JESD 201 class 2 whisker test

ABSOLUTE MAXIMUM RATINGS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Peak repetitive reverse voltage		V <sub>RRM</sub>		200	V		
Average rectified forward current	per device	I	T <sub>Solderpad</sub> = 170 °C, DC	6			
Average rectilied forward current	per device	I <sub>F(AV)</sub>	$T_{Solderpad} = 169 \ ^{\circ}C, D = 0.5$		A		
Non repetitive peak ourge ourgent	per device		T 05 °C 10 me cinuesidal pulse	173	A		
Non-repetitive peak surge current	per diode	I <sub>FSM</sub>	$T_J = 25 \text{ °C}, 10 \text{ ms}$ sinusoidal pulse	87			
Operating junction and storage temp	Operating junction and storage temperatures			-55 to +175	°C		

Revision: 04-May-17 1 Document Number: 96086 For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

RoHS

Available

COMPLIANT HALOGEN





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<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J$ = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	200	-	-			
Forward voltage, per diode	V <sub>F</sub>	I <sub>F</sub> = 3 A	-	0.88	0.94	V		
i orward voltage, per diode		I <sub>F</sub> = 3 A, T <sub>J</sub> = 150 °C	-	0.71	0.74			
Deverse leckers surrent ner diede		V <sub>R</sub> = V <sub>R</sub> rated	-	-	2			
Reverse leakage current, per diode	I <sub>R</sub>	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	2	40	μA		
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V	-	14	-	pF		

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS			
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t =$	= 50 A/µs, V <sub>R</sub> = 30 V	-	20	-			
Reverse recovery time	+	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>rr</sub> = 0.25 A		-	25			
	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	15	-	ns		
		T <sub>J</sub> = 125 °C		-	25	-			
Deels recovery ourrent	1	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 3 A dI <sub>F</sub> /dt = 200 A/μs V <sub>B</sub> = 160 V	-	2	-	А		
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 125 °C		-	3	-	A		
Daviena maaalaa ahaana	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	12	-	nC		
Reverse recovery charge		T <sub>J</sub> = 125 °C		-	40	-	nC		

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C		
Thermal resistance, junction to ambient, per diode	R <sub>thJA</sub> <sup>(1)(2)</sup>		-	90	103	°C/W		
Thermal resistance, junction to case, per diode	R <sub>thJC</sub> <sup>(3)</sup>		-	2.3	2.6	0/10		

Notes

 $^{(1)}$  The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{thJA}$ 

<sup>(2)</sup> Free air, mounted or recommended copper pad area; thermal resistance R<sub>thJA</sub> - junction to ambient

<sup>(3)</sup> Mounted on infinite heatsink



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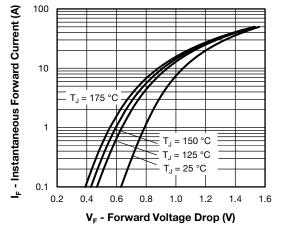


Fig. 1 - Typical Forward Voltage Drop Characteristics

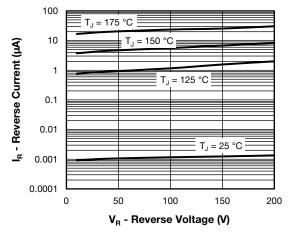


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

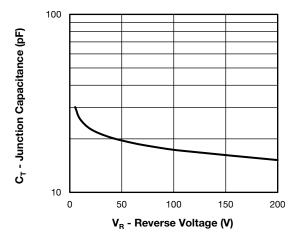


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

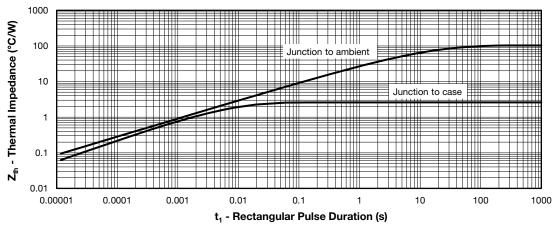
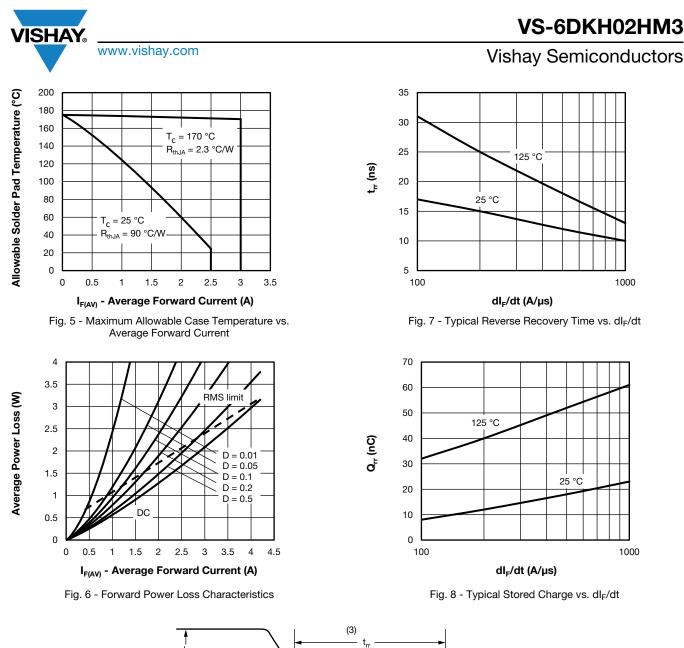


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

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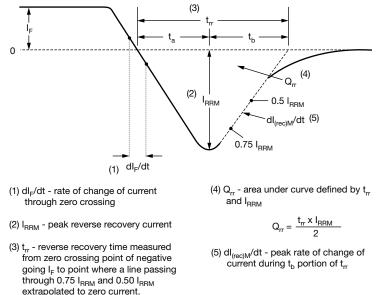


Fig. 9 - Reverse Recovery Waveform and Definitions

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### **ORDERING INFORMATION TABLE**

Device code	VS-	6	D	к	н	02	Н	М3
	1	2	3	4	5	6	7	8
	2	- Cur	rent rati	niconduo ng (6 = 1 iguratior	6 A)	oduct		
	4 5	- K=	•	ted cath < packag pe,				
		- Voli - H =	tage coo AEC-Q	ist recov le (02 = 101 qua en-free,	200 V) alified	complia	nt, and	termina

ORDERING INFORMATION (example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	PACKAGING DESCRIPTION			
VS-6DKH02HM3/H	0.10	н	1500	7"diameter plastic tape and reel			
VS-6DKH02-M3/I	0.10	I	6000	13"diameter plastic tape and reel			

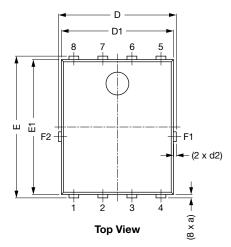
LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?96056				
Part marking information	www.vishay.com/doc?96059			
Packaging information	www.vishay.com/doc?88869			

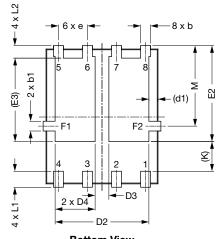




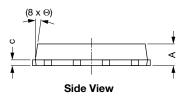
FlatPAK 5 x 6 (Dual)

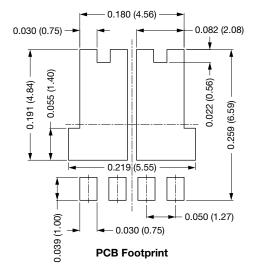
### **DIMENSIONS** in inches (millimeters)











DIM		INCHES			MILLIMETERS	
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.035	0.039	0.043	0.89	0.99	1.09
(a)	-	0.006	-	-	0.15	-
b	0.013	0.017	0.020	0.32	0.43	0.52
b1	0.013	0.017	0.020	0.32	0.43	0.52
С	0.008	-	0.014	0.20	-	0.35
D	0.197	0.203	0.209	5.00	5.15	5.30
D1	0.189	0.193	0.197	4.80	4.90	5.00
D2	0.154	0.161	0.169	3.90	4.10	4.30
D3	0.020	0.024	0.031	0.50	0.60	0.80
D4	0.063	0.069	0.075	1.60	1.75	1.90
(d1)	-	0.016	-	-	0.40	-
(d2)	-	0.005	-	-	0.125	-
E	0.238	0.244	0.250	6.05	6.20	6.35

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## **Outline Dimensions**



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DIM.		INCHES			MILLIMETERS		
DIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
E1	0.228	0.232	0.236	5.80	5.90	6.00	
E2	0.157	0.165	0.173	4.00	4.20	4.40	
(E3)	-	0.144	-	-	3.65	-	
е		0.050 BSC		1.27 BSC			
(K)	0.039	-	-	1.00	-	-	
L1	0.019	-	0.043	0.48	-	1.10	
L2	0.012	-	0.031	0.30	-	0.80	
М	0.128	0.138	0.148	3.25	3.50	3.75	
Θ	0°	-	10°	0°	-	10°	

Notes

٠ Dimensioning and tolerancing per ASME Y14.5-2009

Dimensions D1 and E1 do not include mold flash or gate burrs ٠

Dimension (XX) means reference only ٠



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